

6MBI200XBA120-50

IGBT Modules

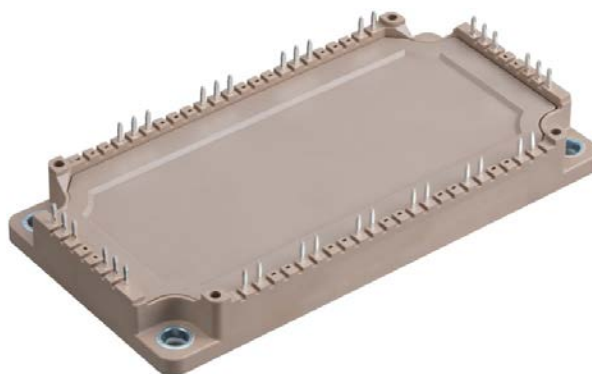
Power Module (X series)
1200V / 200A / 6-in-1 package

■ Features

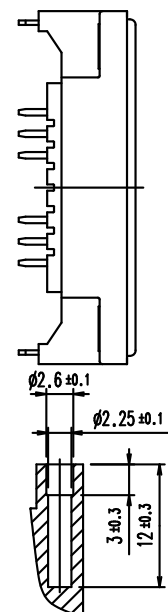
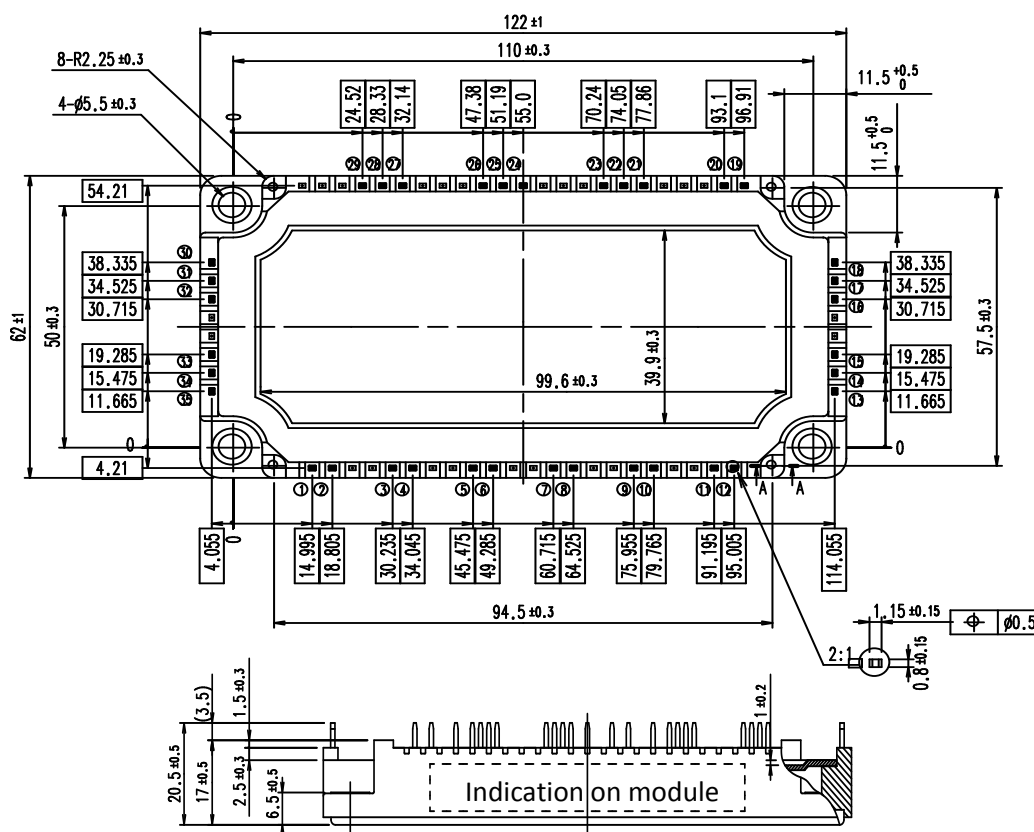
- Low $V_{CE(sat)}$
- Compact Package
- P.C.Board Mount Module
- Converter Diode Bridge Dynamic Brake Circuit
- RoHS compliant Product

■ Applications

- Inverter for Motor Drives,
- AC and DC Servo Drive Amplifier
- Uninterruptible Power Supply



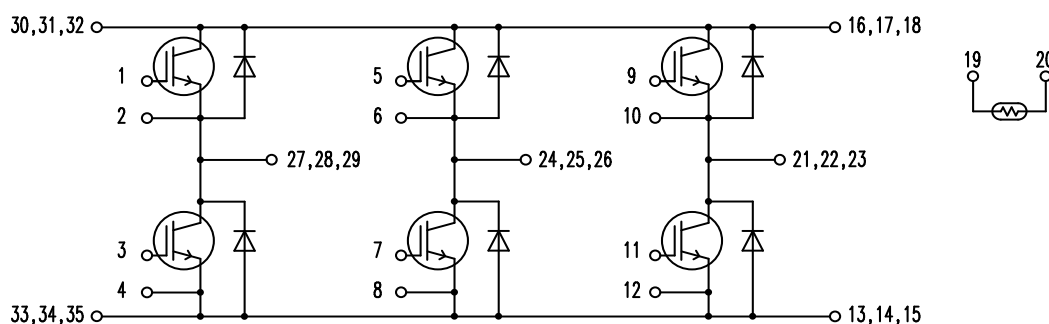
■ Outline drawing (Unit : mm)



Section A-A

Weight: 310 g(typ.)

■ Equivalent Circuit



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■ Absolute Maximum Ratings (at $T_c = 25^\circ\text{C}$ unless otherwise specified)

Items		Symbols	Conditions	Maximum Ratings	Units
Collector-emitter voltage, gate-emitter short-circuited		V_{CES}		1200	V
Gate-emitter voltage, collector-emitter short-circuited		V_{GES}		± 20	V
Collector current		I_C	Continuous $T_c = 80^\circ\text{C}$	200	A
Repetitive peak collector current		I_{CRM}	1ms	400	
Forward current		I_F	Continuous	200	
Repetitive peak forward current		I_{FRM}	1ms	400	
Total power dissipation		P_{tot}	1 device	750	W
Virtual junction temperature		T_{vj}		175	$^\circ\text{C}$
Operating virtual junction temperature		T_{vjop}		175	
Case temperature		T_c		125	
Storage temperature		T_{stg}		-40 ~ 125	
Isolation voltage	between terminal and copper base (*1)	V_{isol}	AC: 1min.	4000	Vrms
	between thermistor and others (*2)				
Mounting torque of screws to heatsink (*3)		M_s	M5	6.0	N·m

(*1) All terminals should be connected together during the test.

(*2) Two thermistor terminals should be connected together, other terminals should be connected together and shorted to base plate during the test.

(*3) Recommendable value : Mounting 2.5 ~ 6.0 N·m (M5)

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■ Electrical characteristics (at $T_{vj} = 25^{\circ}\text{C}$ unless otherwise specified)

Items		Symbols	Conditions		Characteristics			Units
					min.	typ.	max.	
Inverter	Collector-emitter cut-off current, gate-emitter short-circuited	I_{CES}	$V_{GE} = 0V$ $V_{CE} = 1200V$		-	-	50	μA
	Gate leakage current , collector-emitter short-circuited	I_{GES}	$V_{CE}=0V, V_{GE}=\pm 20V$		-	-	100	nA
	Gate-Emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = 20V$ $I_C = 200mA$		6.0	6.5	7.0	V
	Collector-Emitter saturation voltage	$V_{CE(sat)}$ (terminal)	$V_{GE} = 15V$ $I_C = 200A$	$T_{vj}=25^{\circ}C$	-	2.20	2.75	V
		$V_{CE(sat)}$ (chip)		$T_{vj}=25^{\circ}C$	-	1.45	1.90	
				$T_{vj}=125^{\circ}C$	-	1.80	-	
				$T_{vj}=150^{\circ}C$	-	1.90	-	
				$T_{vj}=175^{\circ}C$	-	1.95	-	
	Internal Gate resistance	r_g	-		-	5.00	-	Ω
	Input capacitance	C_{ies}	$V_{CE}=10V, V_{GE}=0V, f=1MHz$		-	21.3	-	nF
	Output capacitance	C_{oes}			-	0.7	-	
	Reverse transfer capacitance	C_{res}			-	0.19	-	
	Gate charge	Q_G	$V_{CC} = 600V, I_C = 200A$ $V_{GE} = -15 \rightarrow +15V$		-	1400.0	-	μC
	Forward on voltage	V_F (terminal)	$V_{GE} = 0V$ $I_F = 200A$	$T_{vj}=25^{\circ}C$	-	2.55	3.10	V
		V_F (chip)		$T_{vj}= 25^{\circ}C$	-	1.80	2.25	
				$T_{vj}=125^{\circ}C$	-	1.85	-	
				$T_{vj}=150^{\circ}C$	-	1.80	-	
				$T_{vj}=175^{\circ}C$	-	1.75	-	
	Turn-on delay time (*1)	$t_{d(on)}$	$V_{CC} = 600V$ $I_C, I_F = 200A$ $V_{GE} = +15/-15 V$ $R_G = 1.8 \Omega$ $L_S = 30 nH$	$T_{vj}= 25^{\circ}C$	-	0.27	-	μs
				$T_{vj}=125^{\circ}C$	-	0.30	-	
$T_{vj}=150^{\circ}C$				-	0.31	-		
$T_{vj}=175^{\circ}C$				-	0.32	-		
Rise time (*1)	t_r	$T_{vj}= 25^{\circ}C$		-	0.08	-		
		$T_{vj}=125^{\circ}C$		-	0.09	-		
		$T_{vj}=150^{\circ}C$		-	0.09	-		
		$T_{vj}=175^{\circ}C$		-	0.10	-		
Turn-off delay time (*1)	$t_{d(off)}$	$T_{vj}= 25^{\circ}C$		-	0.34	-		
		$T_{vj}=125^{\circ}C$		-	0.39	-		
		$T_{vj}=150^{\circ}C$		-	0.40	-		
		$T_{vj}=175^{\circ}C$		-	0.41	-		
Fall time (*1)	t_f	$T_{vj}= 25^{\circ}C$		-	0.12	-		
		$T_{vj}=125^{\circ}C$		-	0.13	-		
		$T_{vj}=150^{\circ}C$		-	0.19	-		
		$T_{vj}=175^{\circ}C$		-	0.10	-		
Reverse recovery time	t_{rr}	$T_{vj}= 25^{\circ}C$		-	0.18	-		
		$T_{vj}=125^{\circ}C$		-	0.23	-		
		$T_{vj}=150^{\circ}C$		-	0.26	-		
		$T_{vj}=175^{\circ}C$		-	0.28	-		

(*1) Turn-on time (t_{on}) = $t_{d(on)} + t_r$, Turn-off time (t_{off}) = $t_{d(off)} + t_f$

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■ Electrical characteristics (at $T_{vj}=25^{\circ}\text{C}$ unless otherwise specified)

Items		Symbols	Conditions		Characteristics			Units
					min.	typ.	max.	
Inverter	Switching loss (per pulse)	E_{on}	$V_{CC} = 600V$	$T_{vj}=25^{\circ}C$	-	16.48	-	mJ
			$I_C, I_F = 200A$	$T_{vj}=125^{\circ}C$	-	23.94	-	
			$V_{GE} = +15/-15 V$	$T_{vj}=150^{\circ}C$	-	26.79	-	
			$R_G = 1.8 \Omega$	$T_{vj}=175^{\circ}C$	-	29.69	-	
		E_{off}	$L_S = 30 nH$	$T_{vj}=25^{\circ}C$	-	14.91	-	
			$T_{vj}=125^{\circ}C$	-	19.28	-		
			$T_{vj}=150^{\circ}C$	-	20.51	-		
			$T_{vj}=175^{\circ}C$	-	21.46	-		
		E_{rr}	$T_{vj}=25^{\circ}C$	-	5.80	-		
			$T_{vj}=125^{\circ}C$	-	9.83	-		
			$T_{vj}=150^{\circ}C$	-	10.60	-		
			$T_{vj}=175^{\circ}C$	-	12.09	-		
Thermistor	Resistance	R	$T = 25^{\circ}C$		-	5000	-	Ω
			$T = 100^{\circ}C$		465	495	520	
	B value	B	$T = 25/ 50^{\circ}C$		3305	3375	3450	K

NOTICE:

The external gate resistance (R_G) shown above is one of our recommended value for the purpose of minimum switching loss. However the optimum R_G depends on circuit configuration and/or environment. We recommend that the R_G has to be carefully chosen based on consideration if IGBT module matches design criteria, for example, switching loss, EMC/EMI, spike voltage, surge current and no unexpected oscillation and so on.

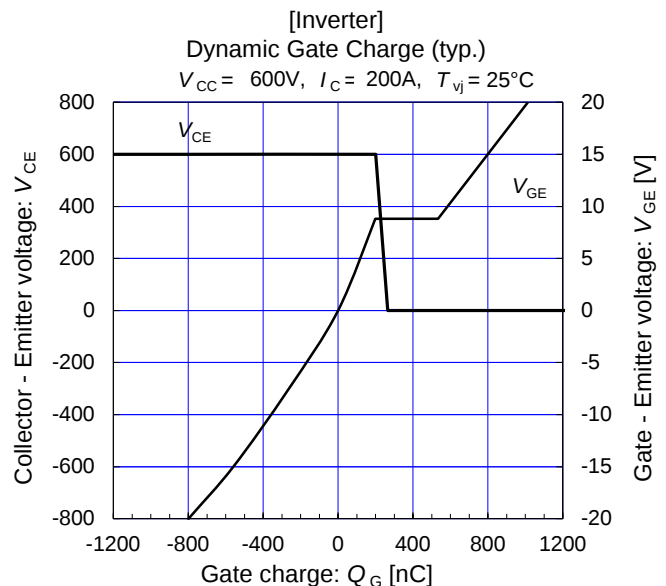
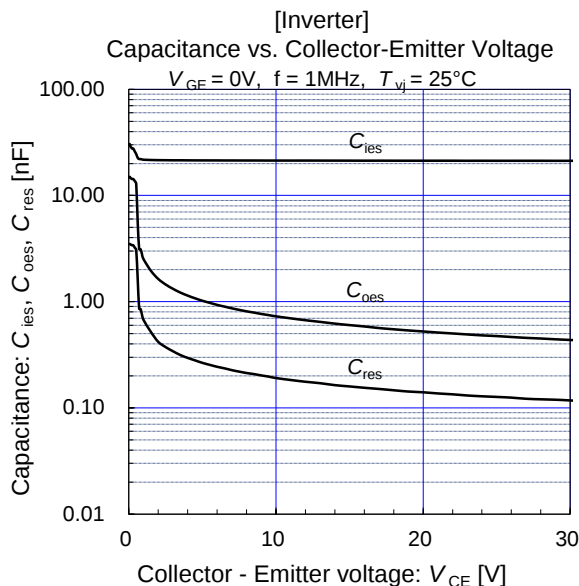
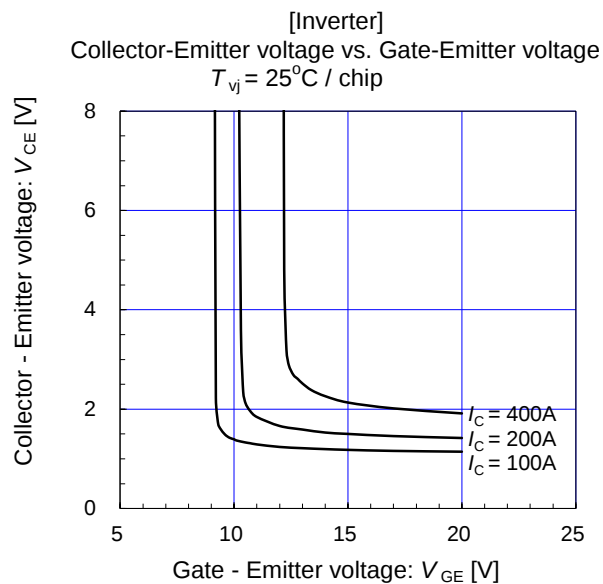
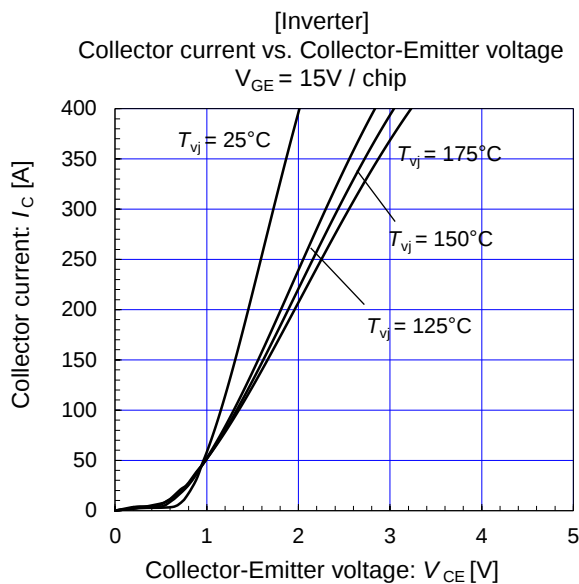
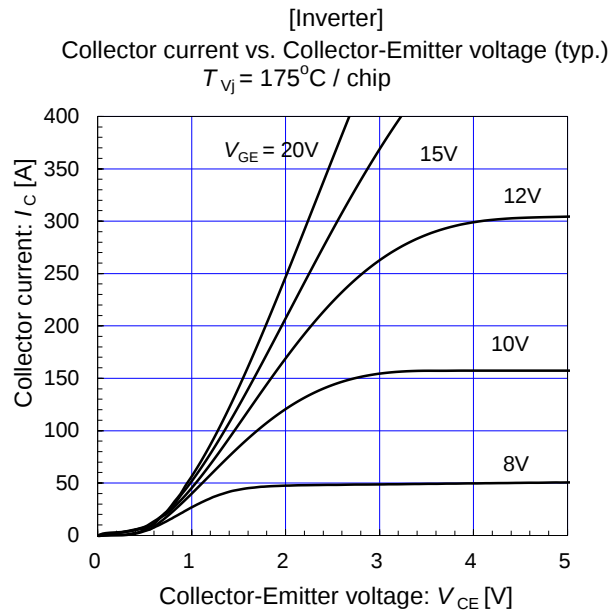
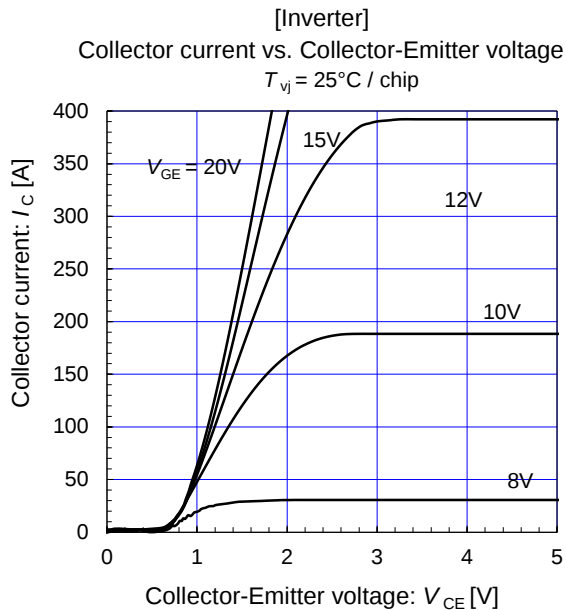
■ Thermal resistance characteristics

Items	Symbols	Conditions	Characteristics			Units
			min.	typ.	max.	
Thermal resistance junction to case (1 device)	$R_{th(j-c)}$	Inverter IGBT	-	-	0.20	$^{\circ}\text{C/W}$
		Inverter FWD	-	-	0.26	
Thermal resistance case to heatsink (1 IGBT + 1 FWD) (*1)	$R_{th(c-s)}$	with 1 W/(m·K) thermal grease	-	0.05	-	

(*1) This is the value which is defined mounting on the additional heatsink with thermal grease.

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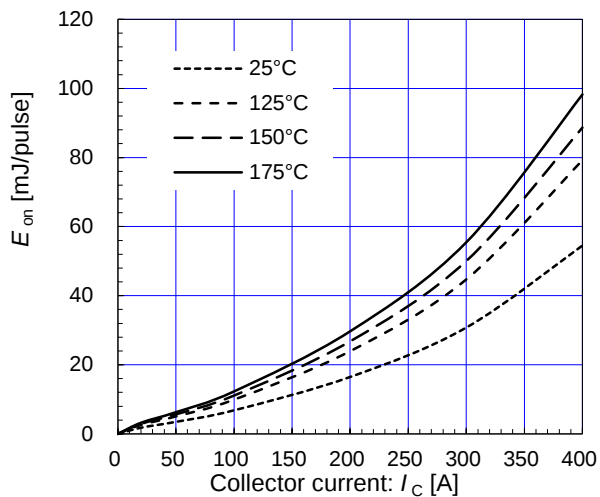
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[Inverter]

E_{on} vs. Collector current (typ.)

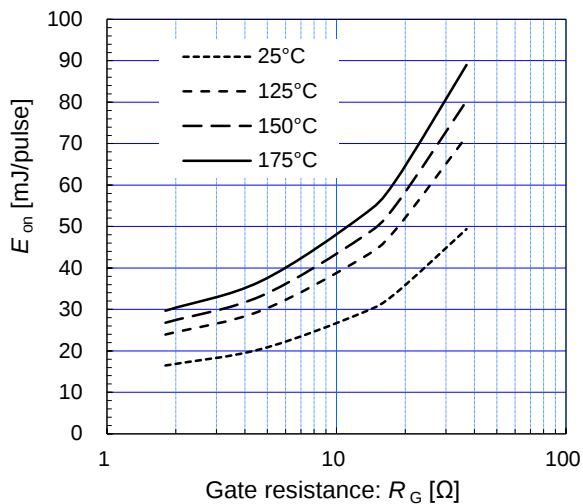
$V_{CC} = 600V$, $V_{GE} = +15/-15V$, $R_G = 1.8\ \Omega$



[Inverter]

E_{on} vs. Gate resistance (typ.)

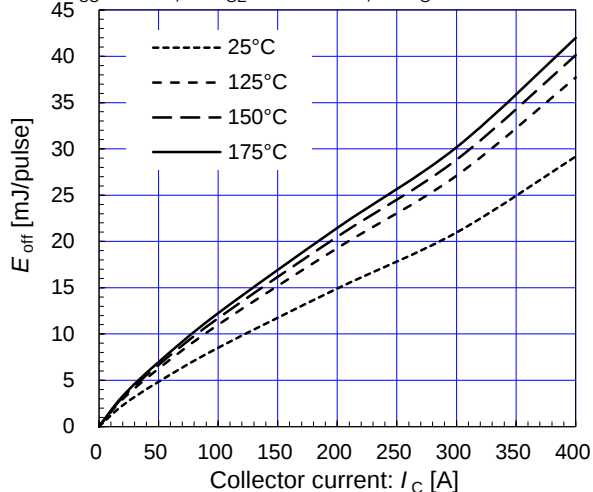
$V_{CC} = 600V$, $V_{GE} = +15/-15V$, $I_C = 200A$



[Inverter]

E_{off} vs. Collector current (typ.)

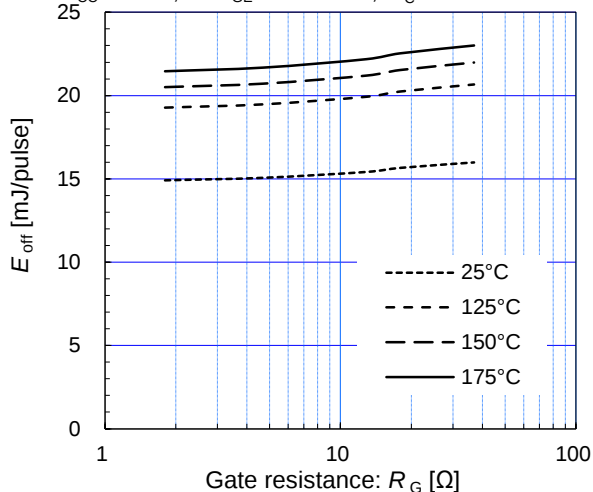
$V_{CC} = 600V$, $V_{GE} = +15/-15V$, $R_G = 1.8\ \Omega$



[Inverter]

E_{off} vs. Gate resistance (typ.)

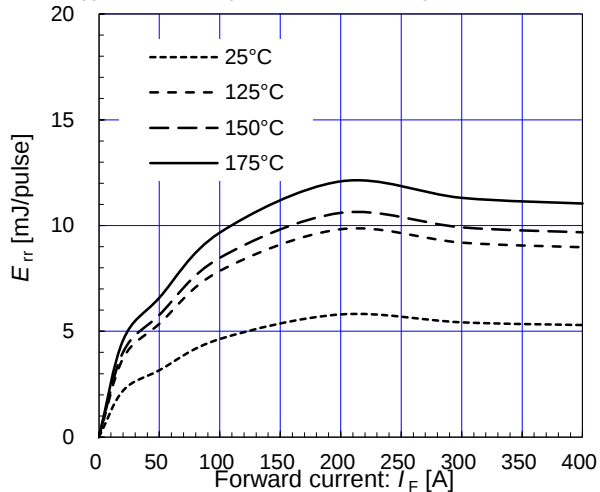
$V_{CC} = 600V$, $V_{GE} = +15/-15V$, $I_C = 200A$



[Inverter]

E_{rr} vs. Forward current (typ.)

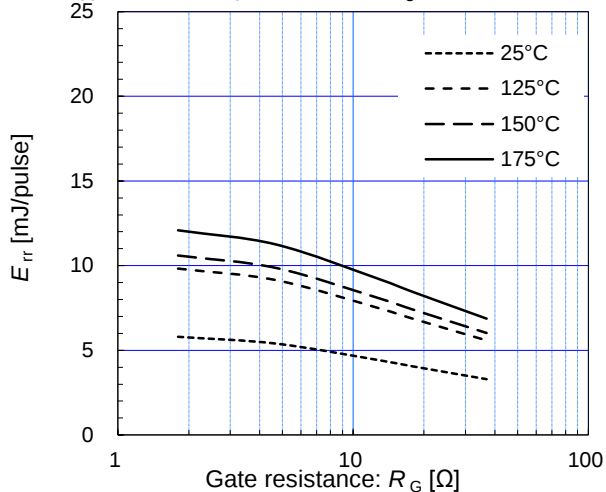
$V_{CC} = 600V$, $V_{GE} = +15/-15V$, $R_G = 1.8\ \Omega$



[Inverter]

E_{rr} vs. Gate resistance (typ.)

$V_{CC} = 600V$, $V_{GE} = +15/-15V$, $I_C = 200A$



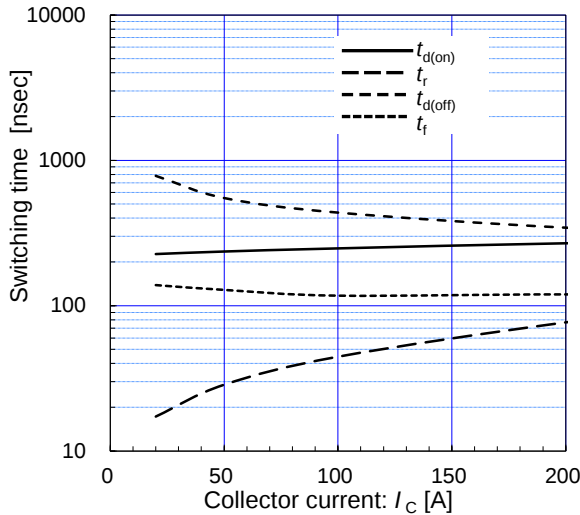
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[Inverter]

Switching time vs. Collector current (typ.)

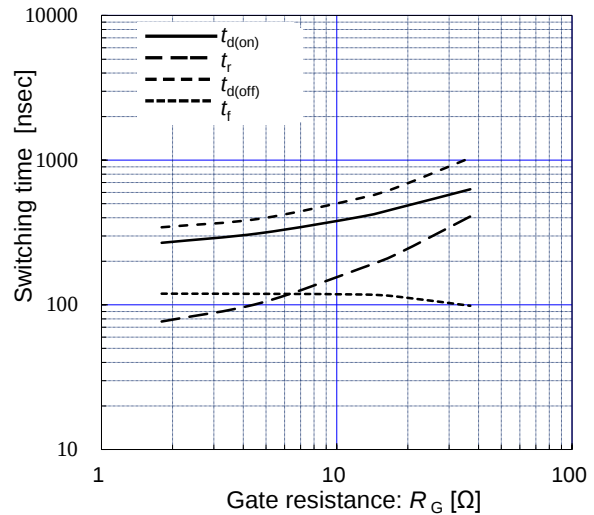
$V_{CC} = 600V$, $R_G = 1.8 \Omega$, $V_{GE} = +15/-15 V$, $T_{vj} = 25^\circ C$



[Inverter]

Switching time vs. Gate resistance (typ.)

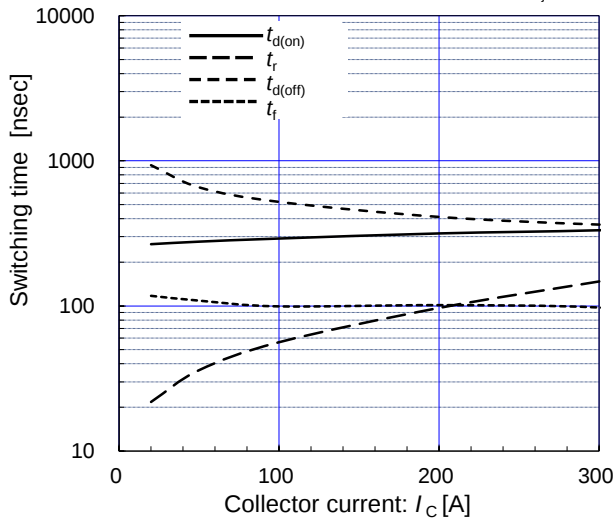
$V_{CC} = 600V$, $I_C = 200A$, $V_{GE} = +15/-15 V$, $T_{vj} = 25^\circ C$



[Inverter]

Switching time vs. Collector current (typ.)

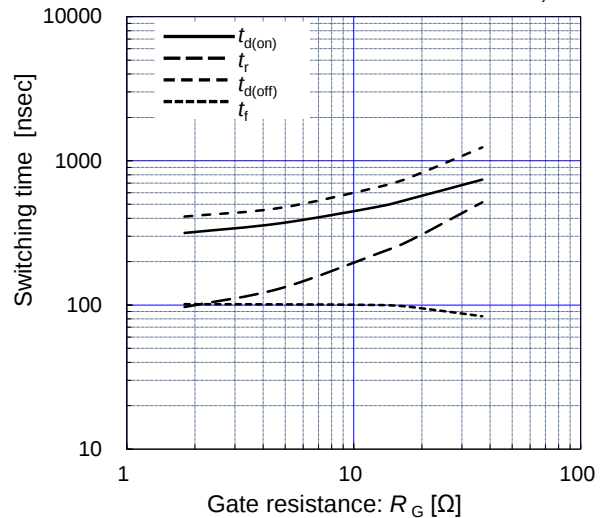
$V_{CC} = 600V$, $R_G = 1.8 \Omega$, $V_{GE} = +15/-15 V$, $T_{vj} = 175^\circ C$



[Inverter]

Switching time vs. Gate resistance (typ.)

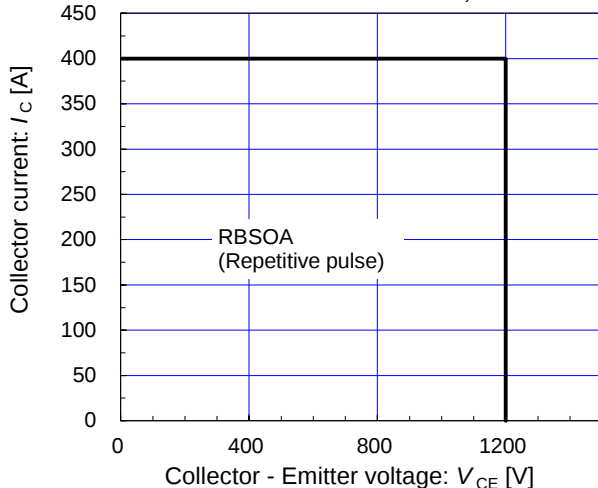
$V_{CC} = 600V$, $I_C = 200A$, $V_{GE} = +15/-15 V$, $T_{vj} = 175^\circ C$



[Inverter]

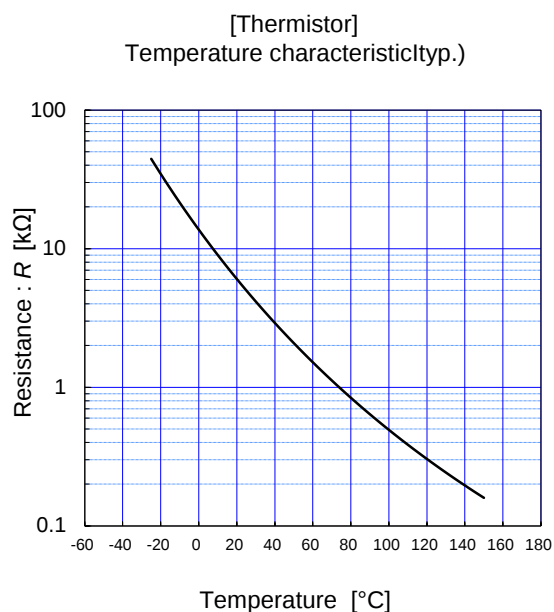
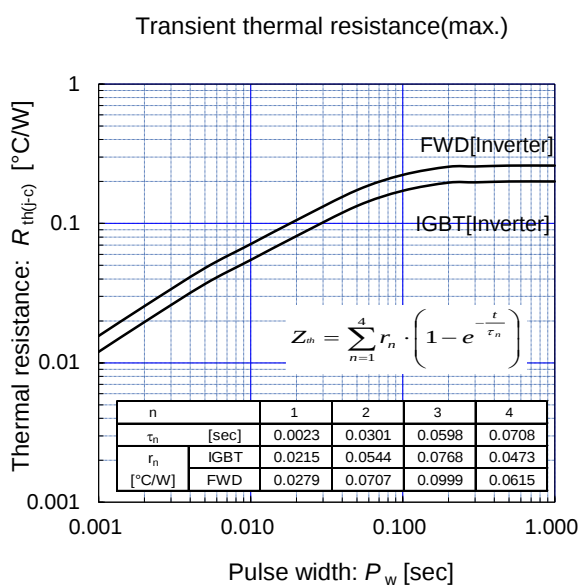
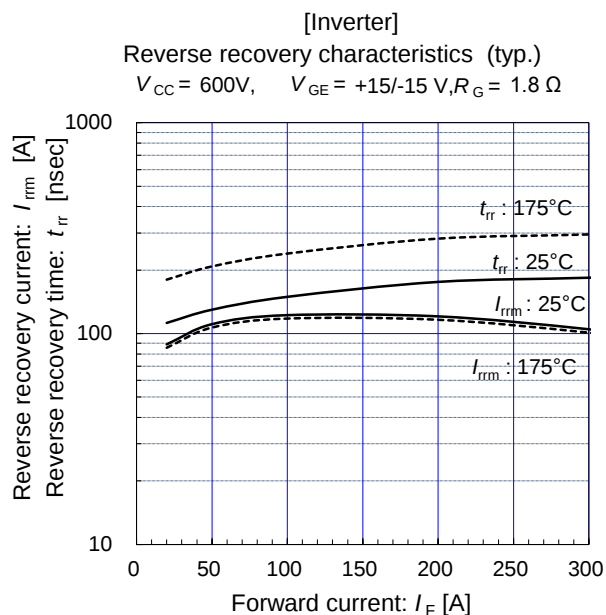
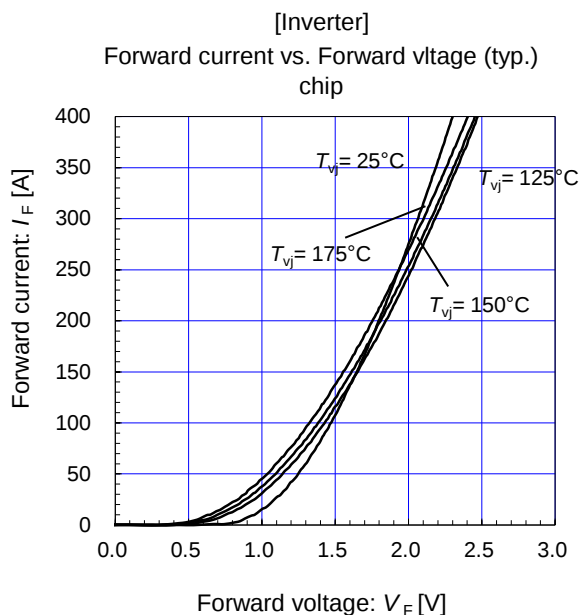
Reverse bias safe operating area (max.)

$V_{GE} = +15/-15 V$, $R_G = 1.8 \Omega$, $T_{vj} = 175^\circ C$



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